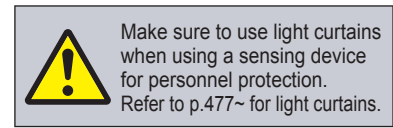


NA1-11

Related Information

- General terms and conditions..... P.1
- Sensor selection guide P.11~ / P.727~
- Glossary of terms..... P.983~
- General precautions P.986~

- FIBER SENSORS
- LASER SENSORS
- PHOTOELECTRIC SENSORS
- MICRO PHOTOELECTRIC SENSORS
- AREA SENSORS
- SAFETY COMPONENTS
- PRESSURE SENSORS
- INDUCTIVE PROXIMITY SENSORS
- PARTICULAR USE SENSORS**
- SENSOR OPTIONS
- WIRE-SAVING SYSTEMS
- MEASUREMENT SENSORS
- STATIC CONTROL DEVICES
- LASER MARKERS

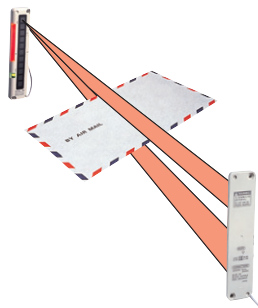


SUNX website <http://www.sunx.com>

Cross-beam scanning system to detect slim objects

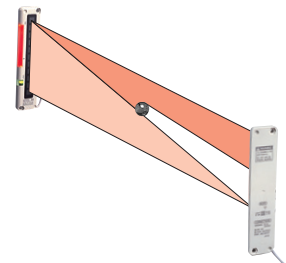
Letter or visiting card detectable!

Slim objects can be detected by using the cross-beam scanning system.



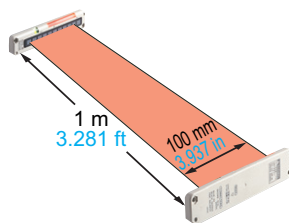
Emitting and receiving element pitch: 10 mm 0.394 in

A minimum sensing object size of $\phi 13.5$ mm $\phi 0.531$ in is realized by using an emitting and receiving element pitch of 10 mm 0.394 in.



Wide area

Though being very slim, it realizes a wide sensing area of 1 m 3.281 ft length and 100 mm 3.937 in width. It is most suitable for object detection on a wide assembly line, or for detecting the dropping of, or incursion by, small objects whose travel path is uncertain.



Just 10 mm 0.394 in thick

It is extremely slim, being just 10 mm 0.394 in thick. Further, it can be mounted in a narrow space since you can select from two cable orientation directions.



It is possible to select from two cable orientation directions.

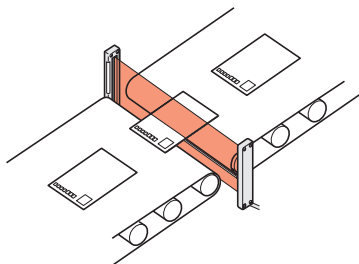
Globally useable

It conforms to the EMC Directive and has UL Recognition. Moreover, PNP output type, which is much in demand in Europe, is also available.

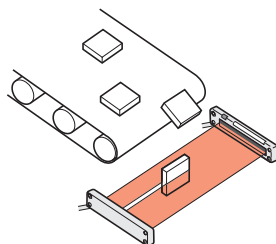
- Selection Guide
- Wafer Detection
- M-DW1**
- HD-T1**
- Liquid Leak Detection
- EX-F70 / EX-F60**
- Liquid Level Detection
- EX-F1**
- Color Mark Detection
- LX-100**
- FZ-10**
- Small / Slim Object Detection
- NA1-11**
- Metal-sheet Double-feed Detection
- GD**
- Other Products

APPLICATIONS

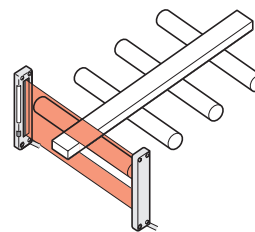
Detecting post-cards



Detecting falling objects whose path is uncertain



Detecting edge of moving object

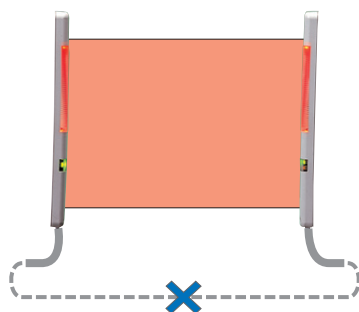


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WARNING Never use this product in any personnel safety application.

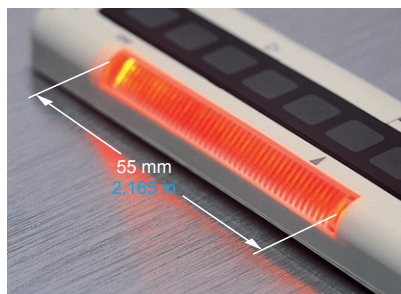
No synchronization wire

Wiring is saved and made simple as no synchronization wire is required between the emitter and the receiver.



Clearly visible indicator

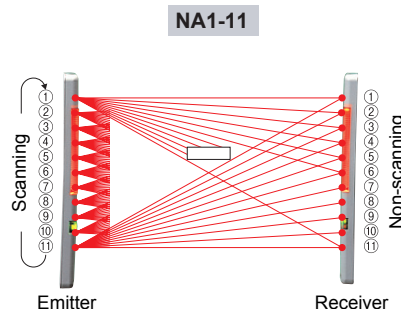
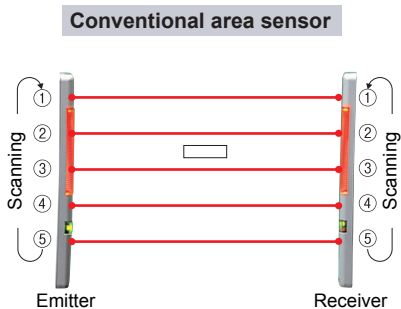
A clearly visible large indicator, having a 55 mm 2.165 in width, is incorporated on both the emitter and the receiver. Further, if the sensing output is directly connected to the large indicator input, the indicator can be conveniently used as a large operation indicator. Moreover, its operation can be selected as lighting or blinking.



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- LX-100**
- FZ-10**
- Small / Slim Object Detection
- NA1-11**
- Metal-sheet Double-feed Detection
- GD**
- Other Products

Cross-beam Scanning System

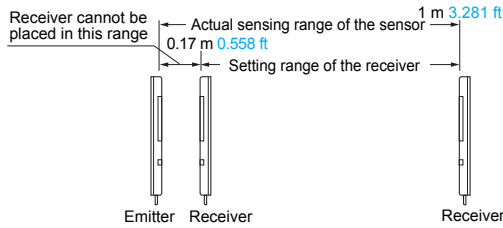
In a conventional area sensor, slim objects cannot be detected since the emitting and the receiving elements are scanned, synchronously, as a set. In contrast, in **NA1-11**, only the elements ① to ⑾ of the emitter are scanned to obtain emission. The elements of the receiver are not scanned, so that when element ① of the emitter emits light, all the elements of the receiver receive light. Hence, even if there is one element on the receiver which does not receive light, it results in light interrupted operation. With this technique, detection of slim objects is possible.



ORDER GUIDE

Type	Appearance	Sensing range (Note1)	Model No.(Note2)	Output
NPN output	<p>Sensing height: 100 mm 3.937 in</p> <p>5 m 16.404 ft cable length</p>	<p>0.17 to 1 m 0.558 to 3.281 ft</p>	NA1-11	NPN open-collector transistor
			NA1-11-C5	
PNP output	<p>No. of elements per emitter / receiver: 11</p> <p>Element pitch: 10 mm 0.394 in</p>		NA1-11-PN	PNP open-collector transistor

Notes: 1) The sensing range is the possible setting distance between the emitter and the receiver. The sensor can detect an object less than 0.17 m 0.558 ft away.



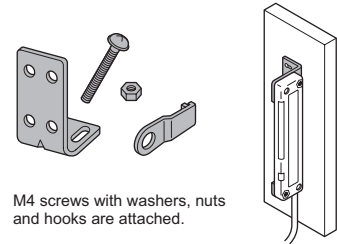
2) The model No. with suffix "P" shown on the label affixed to the product is the emitter, "D" shown on the label is the receiver. (e.g.) Emitter of **NA1-11**: **NA1-11P**, Receiver of **NA1-11**: **NA1-11D**

OPTIONS

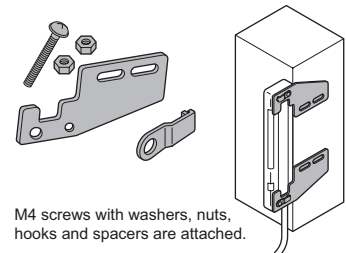
Designation	Model No.	Description
Sensor mounting bracket	MS-NA1-1	Four bracket set Four M4 (length 15 mm 0.591 in) screws with washers, eight nuts, four hooks, four spacers and eight M4 (length 18 mm 0.709 in) screws with washers are attached. (Spacers are not attached with MS-NA1-1 .)
	MS-NA2-1	

Sensor mounting bracket

• **MS-NA1-1**



• **MS-NA2-1**



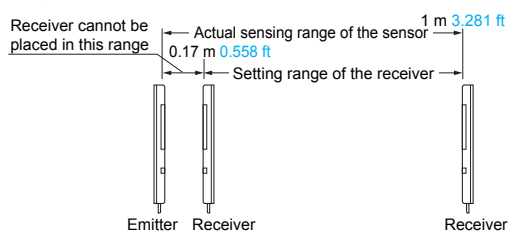
- FIBER SENSORS
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- Multi-sheet Double-feed Detection
- GD**
- Other Products

SPECIFICATIONS

Item	Type	NPN output	PNP output
	Model No.	NA1-11	NA1-11-PN
Sensing height		100 mm 3.937 in	
Sensing range (Note 2)		0.17 to 1 m 0.558 to 3.281 ft	
Element pitch		10 mm 0.394 in	
Number of emitting / receiving elements		11 Nos. each on the emitter and the receiver, respectively	
Sensing object		ø13.5 mm ø0.531 in or more opaque object (Note 3)	
Supply voltage		12 to 24 V DC ± 10 % Ripple P-P 10 % or less	
Current consumption		Emitter: 80 mA or less, Receiver: 100 mA or less	
Output		NPN open-collector transistor <ul style="list-style-type: none"> Maximum sink current: 100 mA Applied voltage: 30 V DC or less (between output and 0 V) Residual voltage: 1 V or less (at 100 mA sink current) 0.4 V or less (at 16 mA sink current) 	PNP open-collector transistor <ul style="list-style-type: none"> Maximum source current: 100 mA Applied voltage: 30 V DC or less (between output and +V) Residual voltage: 1 V or less (at 100 mA source current) 0.4 V or less (at 16 mA source current)
	Utilization category	DC-12 or DC-13	
	Output operation	ON or OFF when beam channel is interrupted, selectable by operation mode switch	
	Short-circuit protection	Incorporated	
Response time		In Dark state: 5 ms or less, In Light state: 10 ms or less	
Indicators	Emitter	Power indicator: Green LED (lights up when the power is ON) Large indicator: Orange LED (lights up or blinks when the large indicator input is Low, lighting pattern is selected by operation mode switch)	Power indicator: Green LED (lights up when the power is ON) Large indicator: Orange LED (lights up or blinks when the large indicator input is High, lighting pattern is selected by operation mode switch)
	Receiver	Operation indicator: Orange LED (lights up when the output is ON) Power indicator: Green LED (lights up when the power is ON) Large indicator: Orange LED (lights up or blinks when the large indicator input is Low, lighting pattern is selected by operation mode switch)	Operation indicator: Orange LED (lights up when the output is ON) Power indicator: Green LED (lights up when the power is ON) Large indicator: Orange LED (lights up or blinks when the large indicator input is High, lighting pattern is selected by operation mode switch)
Environmental resistance	Pollution degree	3 (Industrial environment)	
	Protection	IP62 (IEC) (Refer to p.984 for details of standards)	
	Ambient temperature	-10 to 55 °C +14 to +131 °F (No dew condensation or icing allowed), Storage: -20 to +70 °C -4 to +158 °F	
	Ambient humidity	35 to 85 % RH, Storage: 35 to 85 % RH	
	Ambient illuminance	Incandescent light: 3,000 lx at the light-receiving face	
	EMC	EN 60947-5-2	
	Voltage withstandability	1,000 V AC for one min. between all supply terminals connected together and enclosure	
	Insulation resistance	20 MΩ, or more, with 250 V DC megger between all supply terminals connected together and enclosure	
	Vibration resistance	10 to 150 Hz frequency, 1.5 mm 0.059 in amplitude in X, Y and Z directions for two hours each	
Shock resistance	500 m/s ² acceleration (50 G approx.) in X, Y and Z directions for three times each		
Emitting element		Infrared LED (Peak emission wavelength: 880nm 0.035mil , cross-beam scanning system)	
Material		Enclosure: Heat-resistant ABS, Lens: Acrylic, Indicator cover: Acrylic	
Cable		0.3 mm ² 4-core (emitter: 3-core) oil resistant cabtyre cable, 2 m 6.562 ft long	
Cable extension		Extension up to total 100 m 328.084 ft is possible, for both emitter and receiver, with 0.3 mm ² , or more, cable.	
Weight		Net weight: Emitter 80 g approx., Receiver 85 g approx, Gross Weight: 210 g approx.	

Notes: 1) Where measurement conditions have not been specified precisely, the conditions used were an ambient temperature of +23 °C **+73.4 °F**.

2) The sensing range is the possible setting distance between the emitter and the receiver. The sensor can detect an object less than 0.17 m **0.558 ft** away.



3) Although this product can detect slim objects by using the cross-beam scanning system, the size of the slim object which can be stably detected differs with the setting distance. When this sensor is used to detect slim objects, make sure to confirm stable detection using the actual objects.

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Wafer Detection

M-DW1**HD-T1**

Liquid Leak Detection

EX-F70 / EX-F60

Liquid Level Detection

EX-F1

Color Mark Detection

LX-100**FZ-10**

Small / Slim Object Detection

NA1-11

Metal-sheet Double-Feed Detection

GD

Other Products

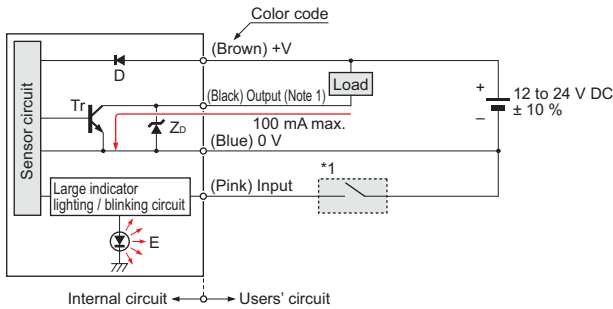
FIBER SENSORS
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Mid-sheet Double-feed Detection
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Other Products

I/O CIRCUIT AND WIRING DIAGRAMS

NA1-11

NPN output type

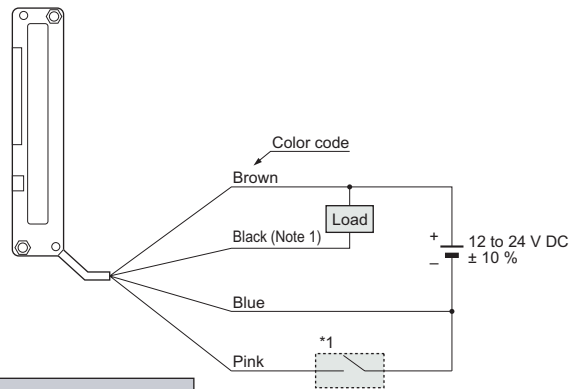
I/O circuit diagram



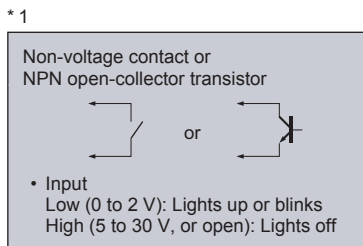
- Notes: 1) The emitter does not incorporate the output (black).
 2) Unused wires must be insulated to ensure that they do not come into contact with wires already in use.

Symbols ... D : Reverse supply polarity protection diode
 Zd: Surge absorption zener diode
 Tr : NPN output transistor
 E : Large indicator (INDICATOR)

Wiring diagram



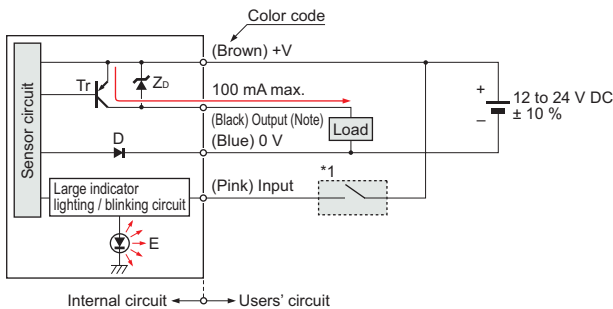
- Notes: 1) The emitter does not incorporate the black lead wire.
 2) Unused wires must be insulated to ensure that they do not come into contact with wires already in use.



NA1-11-PN

PNP output type

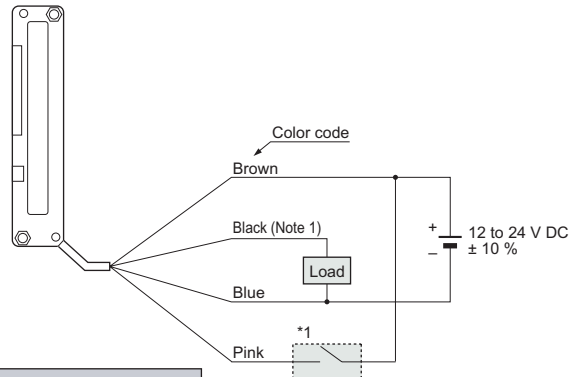
I/O circuit diagram



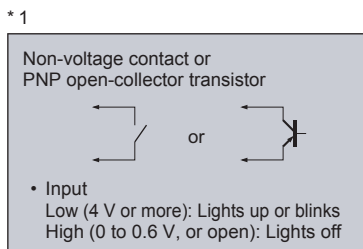
- Notes: 1) The emitter does not incorporate the output (black).
 2) Unused wires must be insulated to ensure that they do not come into contact with wires already in use.

Symbols ... D : Reverse supply polarity protection diode
 Zd: Surge absorption zener diode
 Tr : PNP output transistor
 E : Large indicator (INDICATOR)

Wiring diagram

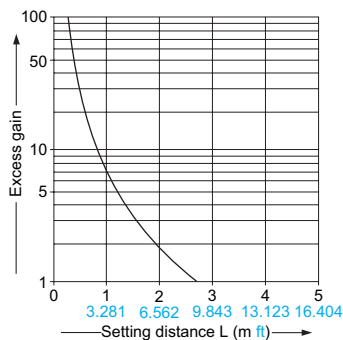


- Notes: 1) The emitter does not incorporate the black lead wire.
 2) Unused wires must be insulated to ensure that they do not come into contact with wires already in use.



SENSING CHARACTERISTICS (TYPICAL)

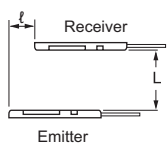
Correlation between setting distance and excess gain



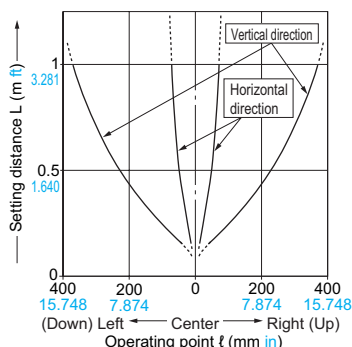
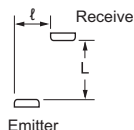
SENSING CHARACTERISTICS (TYPICAL)

Parallel deviation

Vertical direction

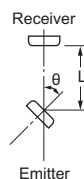


Horizontal direction

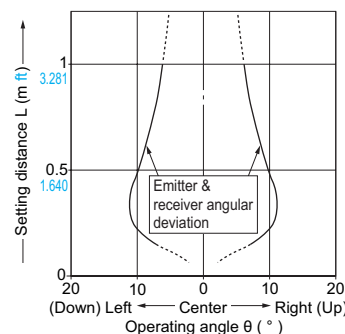
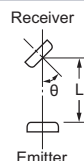


Angular deviation

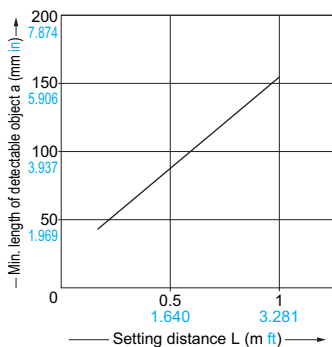
Emitter angular deviation



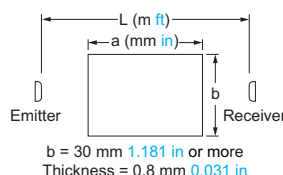
Receiver angular deviation



Correlation between setting distance and minimum length of detectable object



The minimum length of the detectable object, which lies in a plane perpendicular to the sensor front surface, varies with the setting distance, as shown in the left graph. However, note that the minimum length of the detectable object also varies with the object thickness.



* The sensing object is considered to be placed at the center of the sensing area.

PRECAUTIONS FOR PROPER USE

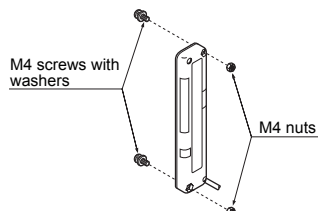
Refer to p.986~ for general precautions.



- Never use this product as a sensing device for personnel protection.
- For sensing devices to be used as safety devices for press machines or for personnel protection, use products which meet laws and standards, such as OSHA, ANSI or IEC etc., for personnel protection applicable in each region or country.
- If this product is used as a sensing device for personnel protection, death or serious body injury could result.
- For a product which meets safety standards, use the following products.
Type 4: **SF4B** series (P.481~)
Type 2: **SF2B** series (P.515~)

Mounting

- Use M4 screws with washers and M4 nuts. The tightening torque should be 0.5 N·m or less. (Please arrange the screws and nuts separately.)



Selection of large indicator operation

- Lighting / Blinking is selected by the operation mode switch on the emitter and the receiver.

Operation of large indicator	Operation mode switch	
	Emitter	Receiver
Lighting	LIGHT <input type="checkbox"/> BLINK <input checked="" type="checkbox"/>	LIGHT <input checked="" type="checkbox"/> BLINK <input type="checkbox"/>
Blinking	LIGHT <input checked="" type="checkbox"/> BLINK <input type="checkbox"/>	LIGHT <input type="checkbox"/> BLINK <input checked="" type="checkbox"/>

Selection of output operation

- The output operation mode is selected by the operation mode switch on the receiver.

(The switches must be set with the power supply off. The operation mode does not change if the switch setting is changed with the power supplied.)

Operation mode switch (Receiver)	Output operation	Operation indicator (Orange)
D-ON <input type="checkbox"/> L-ON <input checked="" type="checkbox"/>	ON in Dark state	Lights up when the output is ON
L-ON <input checked="" type="checkbox"/> D-ON <input type="checkbox"/>	OFF in Dark state	Lights up when the output is ON

Note: LIGHT / BLINK switch is not related to the output operation selection.

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Liquid Level Detection

EX-F1

Color Mark Detection

LX-100

FZ-10

Small / Slim Object Detection

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Metal-sheet Double-Feed Detection

GD

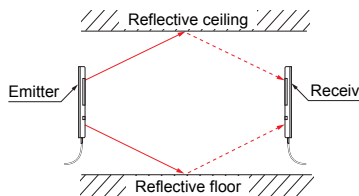
Other Products

PRECAUTIONS FOR PROPER USE

Refer to p.986~ for general precautions.

Others

- Do not use during the initial transient time (0.5 sec.) after the power supply is switched on.
- Although this sensor can detect slim objects by using the cross-beam scanning system, the size of the slim object which can be stably detected differs with the setting distance. Hence, when the sensor is used to detect slim objects, make sure to confirm stable detection using the actual objects.
- In case of this sensor, light from the emitter spreads above and below the sensor. Hence, take care that if there is a reflective object above or below the sensor it will affect the sensing.



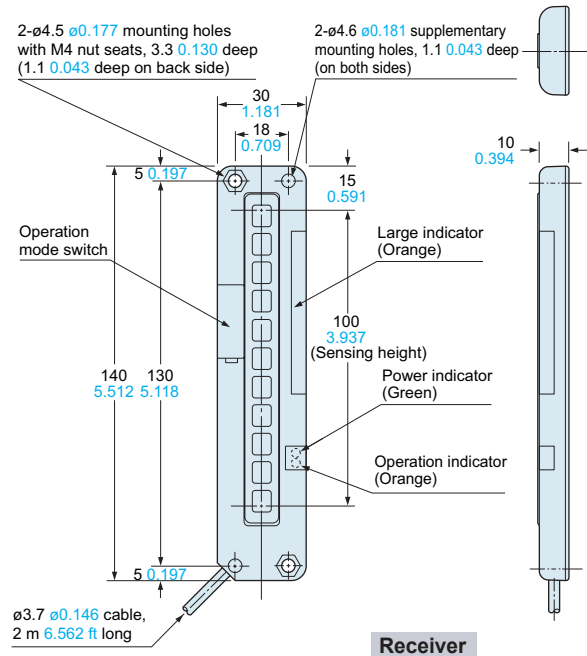
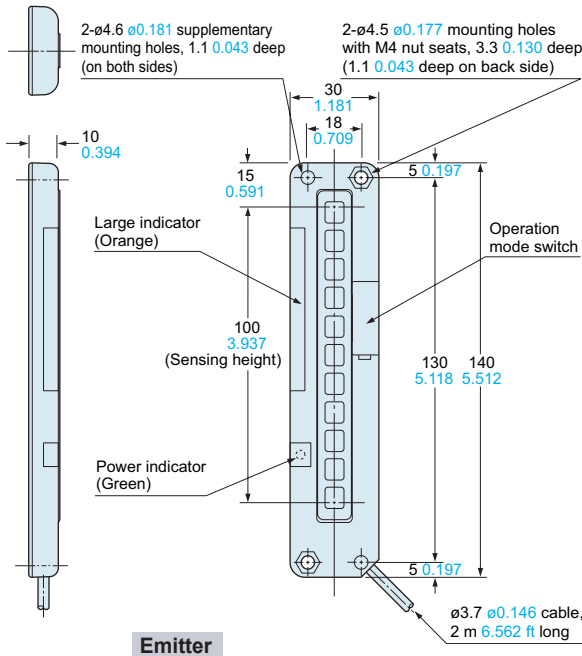
* Refer to "Parallel deviation" on p.768.

DIMENSIONS (Unit: mm in)

The CAD data in the dimensions can be downloaded from the SUNX website: <http://www.sunx.com>

NA1-11 NA1-11-PN

Sensor



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EX-F1
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Medical-sheet Double-head Detection
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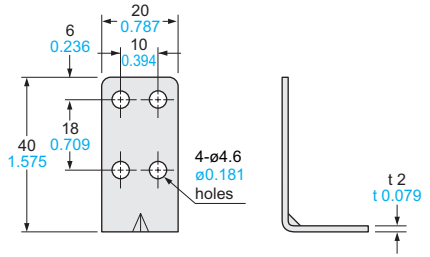
DIMENSIONS (Unit: mm in) The CAD data in the dimensions can be downloaded from the SUNX website: <http://www.sunx.com>

MS-NA1-1

Sensor mounting bracket (Optional)

Assembly dimensions

Mounting drawing with the receiver

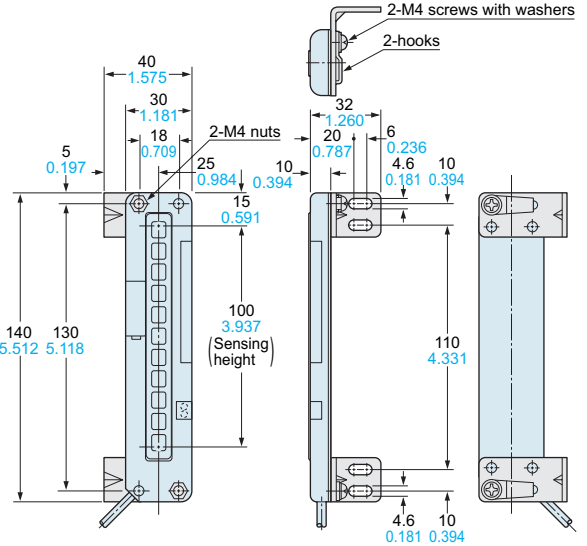
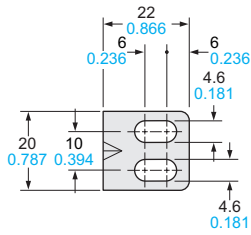


Material: Cold rolled carbon steel (SPCC)
(Uni-chrome plated)

Four bracket set

Four M4 (length 15 mm 0.591 in) screws with washers, eight nuts, four hooks and eight M4 (length 18 mm 0.709 in) screws with washers are attached.

M4 (length 18 mm 0.709 in) screws with washers are not used for NA1-11.

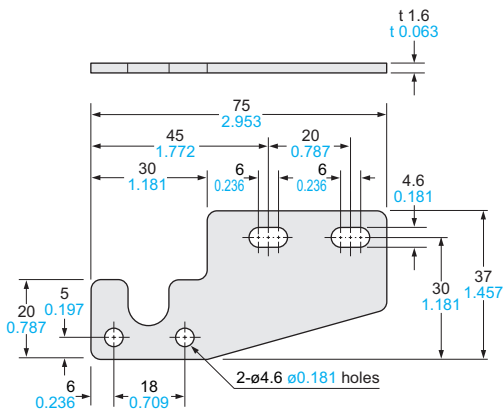


MS-NA2-1

Sensor mounting bracket (Optional)

Assembly dimensions

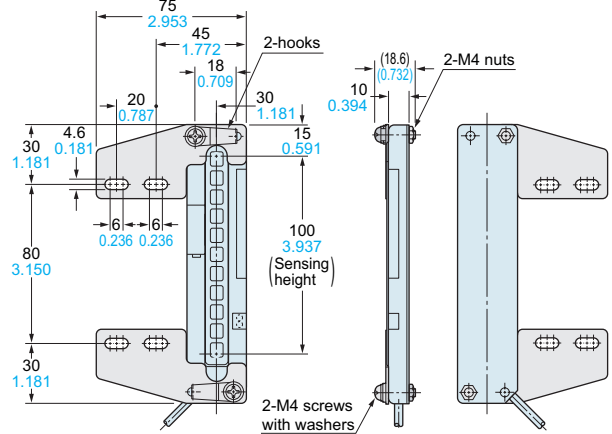
Mounting drawing with the receiver



Material: Cold rolled carbon steel (SPCC)
(Uni-chrome plated)

Four bracket set

Four M4 (length 15 mm 0.591 in) screws with washers, eight nuts, four hooks, four spacers and eight M4 (length 18 mm 0.709 in) screws with washers are attached.



FIBER SENSORS

LASER SENSORS

PHOTO-ELECTRIC SENSORS

MICRO PHOTO-ELECTRIC SENSORS

AREA SENSORS

SAFETY COMPONENTS

PRESSURE SENSORS

INDUCTIVE PROXIMITY SENSORS

PARTICULAR USE SENSORS

SENSOR OPTIONS

WIRE-SAVING SYSTEMS

MEASUREMENT SENSORS

STATIC CONTROL DEVICES

LASER MARKERS

Selection Guide

Wafer Detection

M-DW1

HD-T1

Liquid Leak Detection

EX-F70 / EX-F60

Liquid Level Detection

EX-F1

Color Mark Detection

LX-100

FZ-10

Small / Slim Object Detection

NA1-11

Metal-sheet Double-Head Detection

GD

Other Products